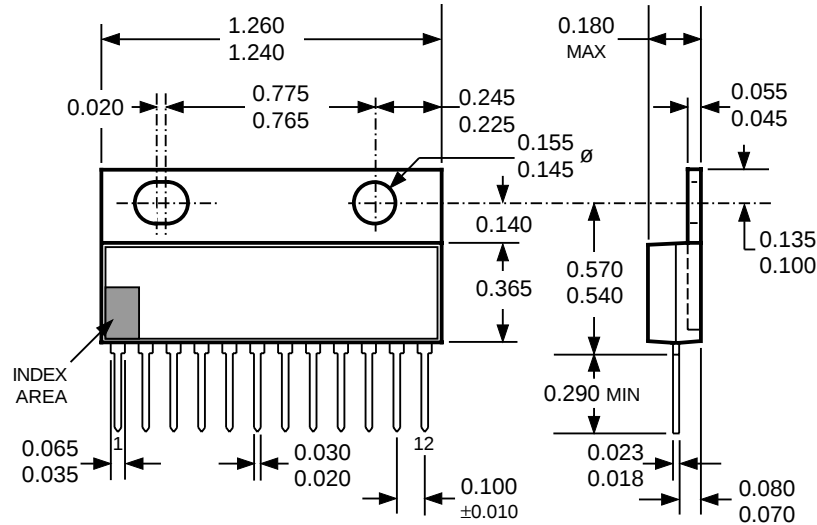


PACKAGE OUTLINES

PLASTIC POWER-TAB SIP

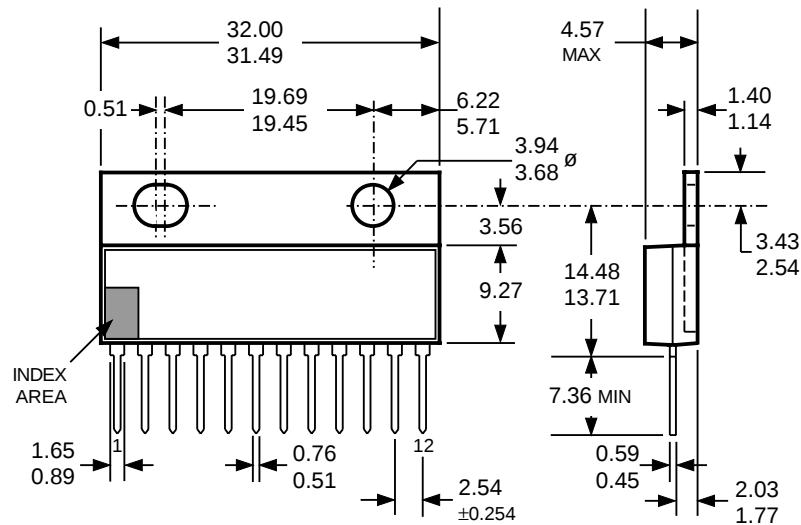
PACKAGE DESIGNATOR W

Dimensions in Inches
(controlling dimensions)



Dwg. MP-007 in

Dimensions in Millimeters
(for reference only)



Dwg. MP-007 mm

- NOTES:
1. Lead thickness is measured at seating plane or below.
 2. Lead spacing tolerance is non-cumulative.
 3. Exact body and lead configuration at vendor's option within limits shown.
 4. Lead gauge plane is 0.030" (0.762 mm) below seating plane.

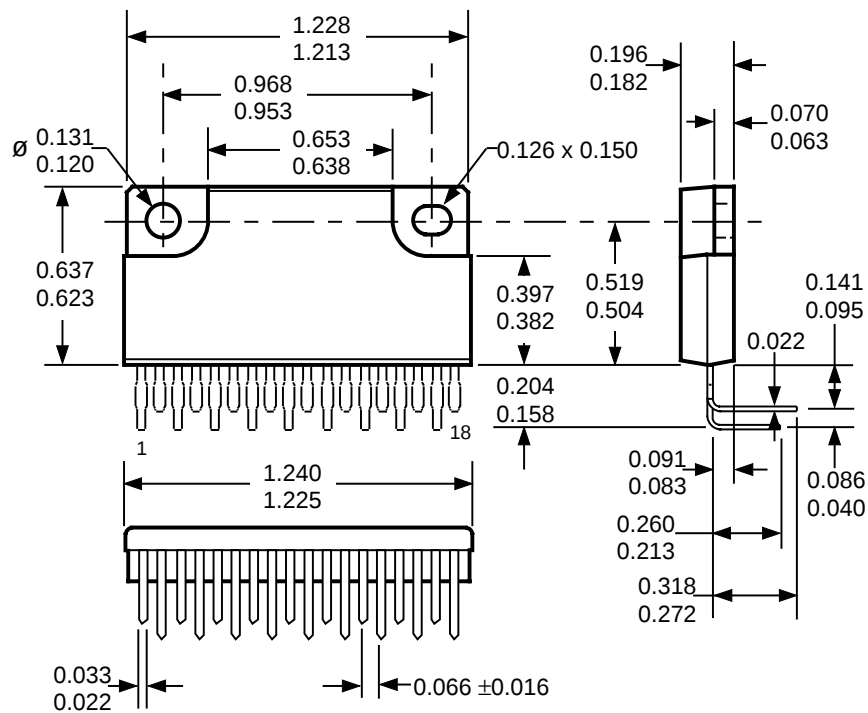
PACKAGE OUTLINES

PLASTIC POWER-TAB SIP (with lead forming for horizontal mounting)

PACKAGE DESIGNATOR WH

Dimensions in Inches

(for reference only)



Dwg. MP-006 in

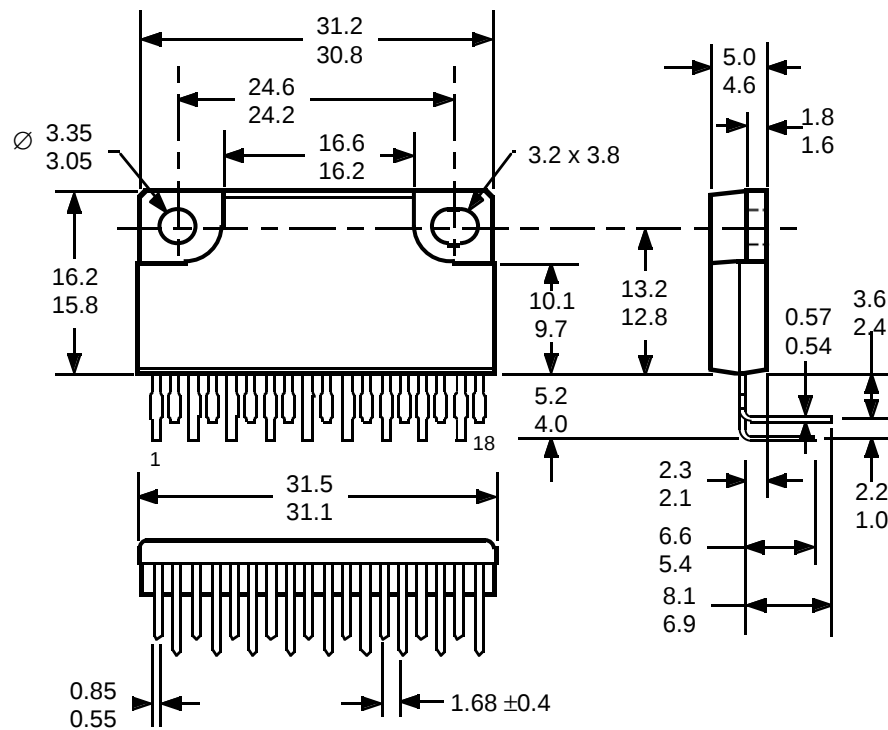
PACKAGE OUTLINES

PLASTIC POWER-TAB SIP (with lead forming for horizontal mounting)

PACKAGE DESIGNATOR WH

Dimensions in Millimeters

(controlling dimensions)



Dwg. MP-006 mm

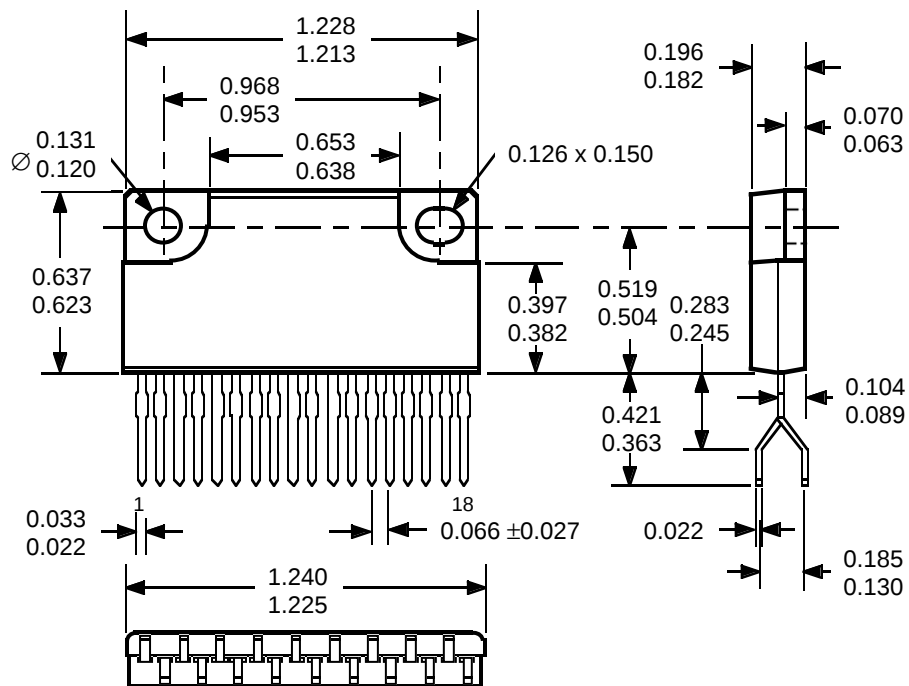
PACKAGE OUTLINES

PLASTIC POWER-TAB SIP (with lead forming for vertical mounting)

PACKAGE DESIGNATOR WV

Dimensions in Inches

(for reference only)



Dwg. MP-004 in

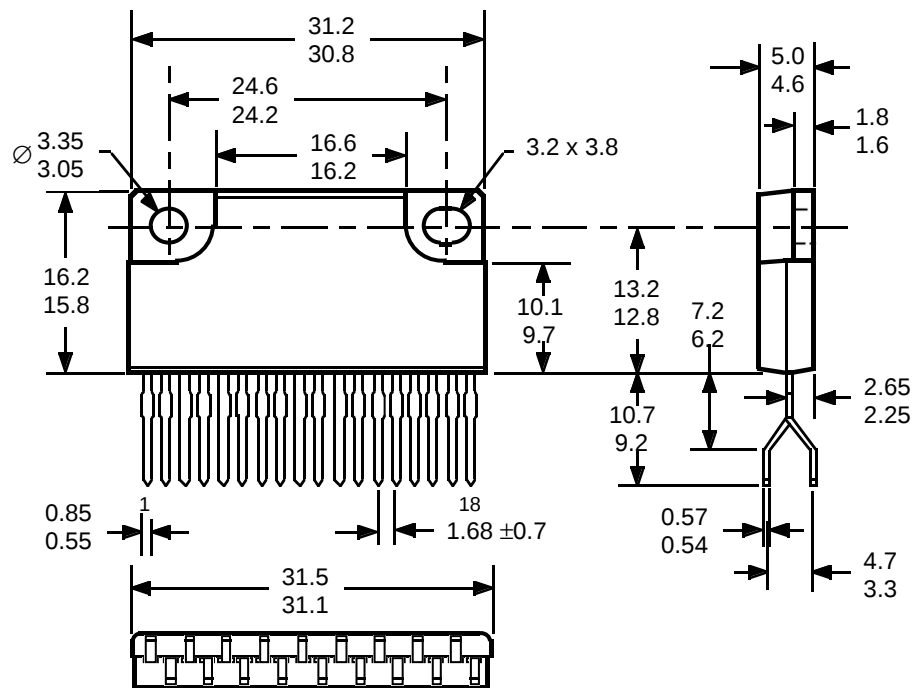
PACKAGE OUTLINES

PLASTIC POWER-TAB SIP (with lead forming for vertical mounting)

PACKAGE DESIGNATOR WV

Dimensions in Millimeters

(controlling dimensions)



Dwg. MP-004 mm

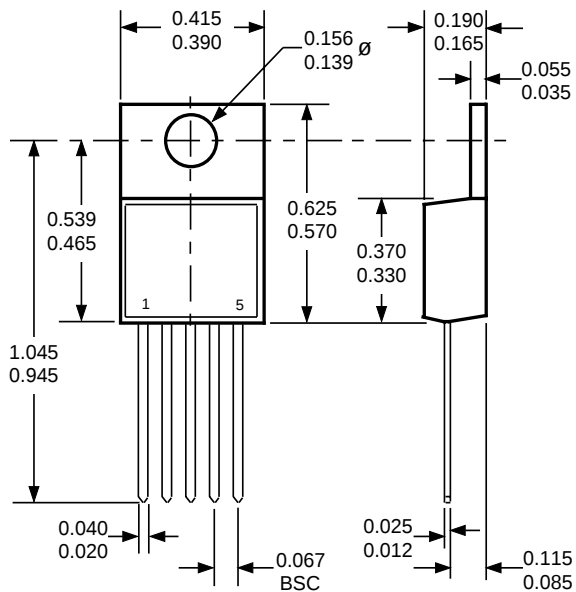
PACKAGE OUTLINES

PLASTIC POWER-TAB SIP

PACKAGE DESIGNATOR Z

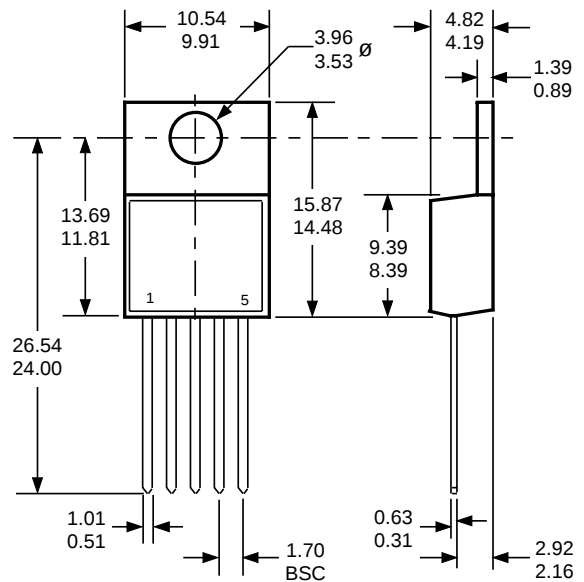
(JEDEC outline TS-001)

Dimensions in Inches
(controlling dimensions)



Dwg. MP-005 in

Dimensions in Millimeters
(for reference only)



Dwg. MP-005 mm